



# 0.5W Zener Diode - BZX55A\* series

Rev 1.0

0.5W 5mA I<sub>ZT</sub> Silicon Planar Zener diode in bare die form – 1% tolerance, “A” grade 07/04/19

## Features:

- Tight tolerance reverse breakdown voltage
- I<sub>R</sub> characterized at 125°C
- Sharp reverse characteristics
- Low reverse current Levels
- High reliability gold back metal

## Ordering Information

The following part suffixes apply:

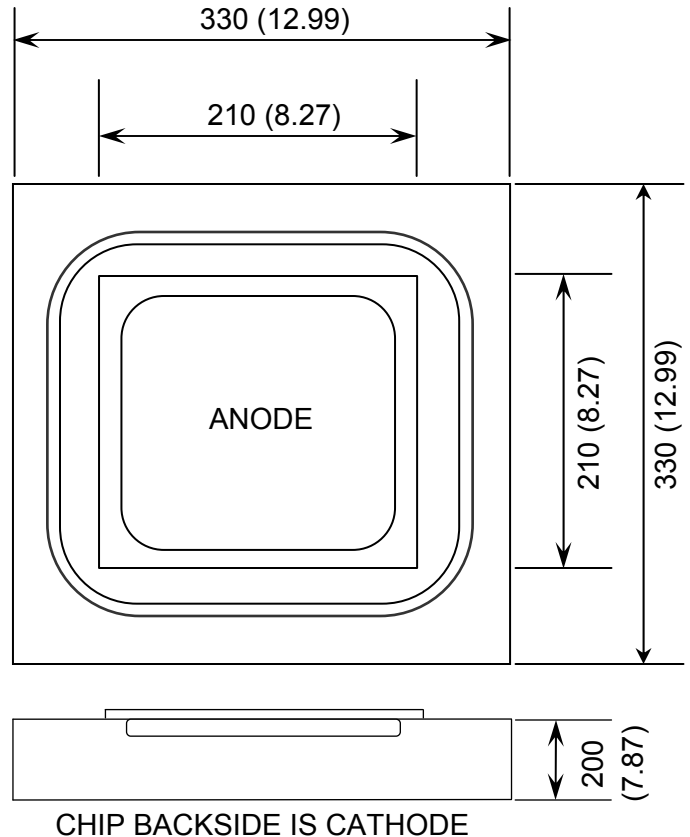
- No suffix - MIL-STD-750 /2073 Visual Inspection
- “H” - MIL-STD-750 /2073 Visual Inspection  
+ MIL-PRF-38534 Class H LAT
- “K” - MIL-STD-750 /2073 Visual Inspection  
+ MIL-PRF-38534 Class K LAT

LAT = Lot Acceptance Test.

For further information on LAT process flows see below.

[www.siliconsupplies.com/quality/bare-die-lot-qualification](http://www.siliconsupplies.com/quality/bare-die-lot-qualification)

## Die Dimensions in μm (mils)



## Supply Formats:

- Default – Die in Waffle Pack (400 per tray capacity)
- Sawn Wafer on Tape – By specific request
- Unsawn Wafer – By specific request
- Lower precision V<sub>Z</sub> tolerances:  
2% - B grade, 5% - C grade

## Mechanical Specification

Die Size (Unsawn)	330 x 330 12.99 x 12.99	μm mils
Anode Pad Size	210 x 210 8.27 x 8.27	μm mils
Die Thickness	200 7.87	μm mils
Top Metal Composition	Al	
Back Metal Composition	Au	





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## Absolute Maximum Ratings<sup>1</sup> $T_A = 25^\circ\text{C}$ unless otherwise stated

PARAMETER	SYMBOL	VALUE	UNIT
Power Dissipation <sup>2</sup>	$P_{TOT}$	500	mW
Junction Temperature	$T_J$	200	$^\circ\text{C}$
Storage Temperature Range	$T_S$	-65 to +200	$^\circ\text{C}$
Forward Voltage @ $I_F = 100\text{mA}$	$V_F$	1.3	V

## Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise stated

DEVICE	ZENER VOLTAGE RANGE			TEST CURRENT		REVERSE LEAKAGE CURRENT			DYNAMIC RESISTANCE	
	$V_Z @ I_{ZT1}$			$I_{ZT1}$	$I_{ZT2}$	$I_R @ V_R$			$Z_Z @ I_{ZT1}$	$Z_{ZK} @ I_{ZT2}$
	V			mA		$T_A = 25^\circ\text{C}$	$T_A = 125^\circ\text{C}$		f = 1 kHz	
	Min.	Nom.	Max.			$\mu\text{A Max.}$		V	Max.	Max.
BZX55A2V4	2.376	2.4	2.424	5	1	50.0	100	1.0	85	600
BZX55A2V7	2.673	2.7	2.727	5	1	10.0	50	1.0	85	600
BZX55A3V0	2.97	3.0	3.03	5	1	4.0	40	1.0	85	600
BZX55A3V3	3.267	3.3	3.333	5	1	2.0	40	1.0	85	600
BZX55A3V6	3.564	3.6	3.636	5	1	2.0	40	1.0	85	600
BZX55A3V9	3.861	3.9	3.939	5	1	2.0	40	1.0	85	600
BZX55A4V3	4.257	4.3	4.343	5	1	1.0	20	1.0	75	600
BZX55A4V7	4.653	4.7	4.747	5	1	0.5	10	1.0	60	600
BZX55A5V1	5.049	5.1	5.151	5	1	0.1	2.0	1.0	35	550
BZX55A5V6	5.544	5.6	5.656	5	1	0.1	2.0	1.0	25	450
BZX55A6V2	6.138	6.2	6.262	5	1	0.1	2.0	2.0	10	200
BZX55A6V8	6.732	6.8	6.868	5	1	0.1	2.0	3.0	8.0	150
BZX55A7V5	7.425	7.5	7.575	5	1	0.1	2.0	5.0	7.0	50
BZX55A8V2	8.118	8.2	8.282	5	1	0.1	2.0	6.2	7.0	50
BZX55A9V1	9.009	9.1	9.191	5	1	0.1	2.0	6.8	10	50

1. Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum ratings, for extended periods, may reduce device reliability.

2. Assembled in DO-35 package. Performance in die form subject to assembly heat sinking and die attach methods.

Zener Voltages 10V to 75V are constructed using a larger die geometry.

Please see [here](#) for further details

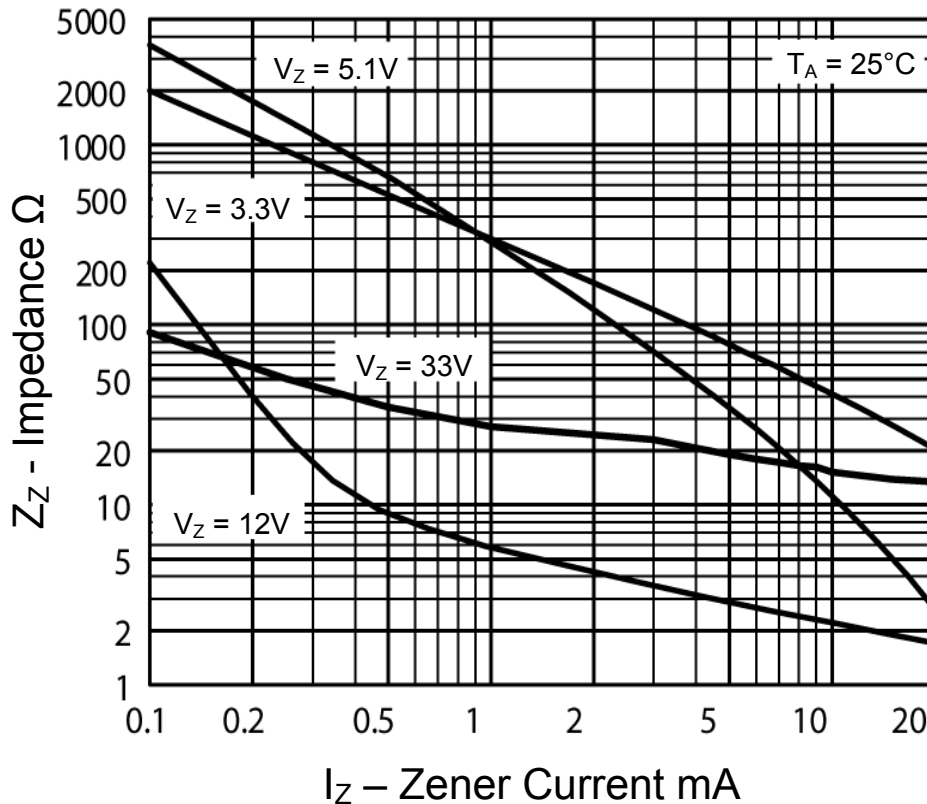




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## Typical Electrical Characteristics



Zener Impedance Versus Operating Current -  $Z_Z$  Versus  $I_Z$

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